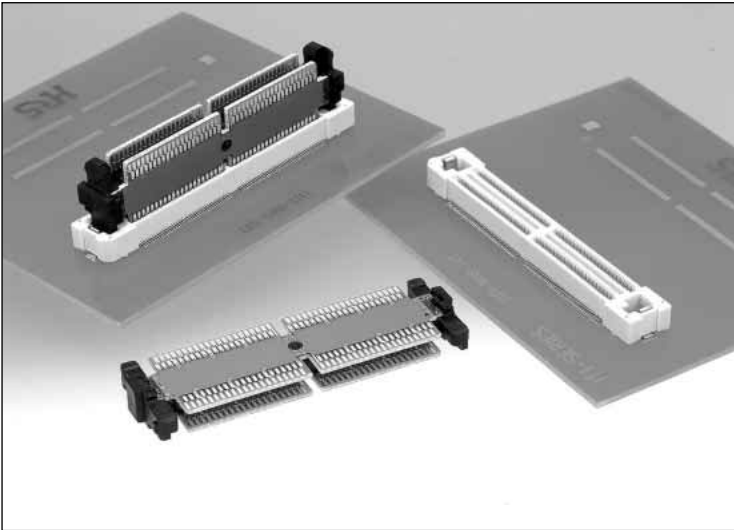


High Speed, Matched-Impedance, Parallel Board-to-board Connector

IT1 Series



IT1 Series Outline

High-speed matched-impedance parallel board-to-board connector designed for applications requiring board-to-board spacing with transmission speeds exceeding 1GHz. The connection system has matched impedance of 50 ohm or can be customized. Contacts are on 0.5mm pitch.

■ Features

1. Impedance Matching using a 4-Layer Board

The innovative transmission module uses PC boards with a strip line design of transmission lines, providing matched impedance of 50 ohms, for standard product.

2. Supports Multiple Connectors per board

Designed with a tolerance of $\pm 0.2\text{mm}$ for both the X and Y-axis. The three-piece structure and the $\pm 0.2\text{mm}$ tolerance allows 3 or more IT1's to be mounted on a single board.

3. Customized Board-to-Board Distance

Board-to-board distance can be customized, from 16mm to 40mm.

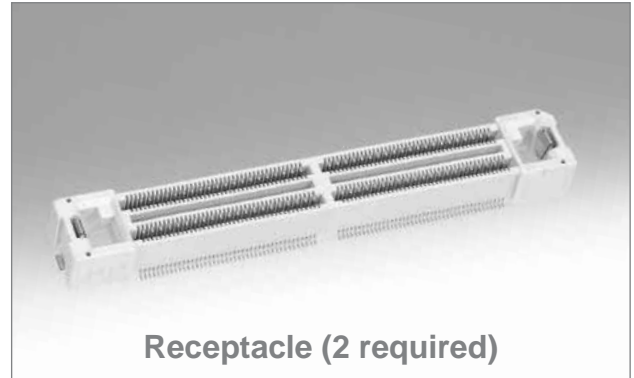
Ground lines or additional traces can be added to support high level, high speed transmission or mixed power/signal applications.

4. Signal to Ground Ratio

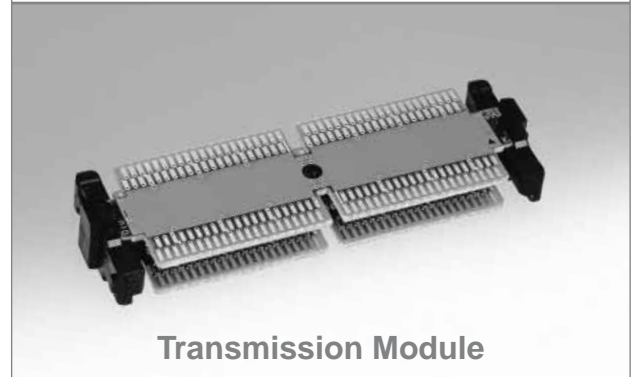
The standard signal-to-ground ratio is 10:2, which makes reliable matching of the characteristic impedance of each transmission line. This ratio also can be customized.

5. Contact Reliability

Use of double contact points on each of the contacts assures highly reliable performance.

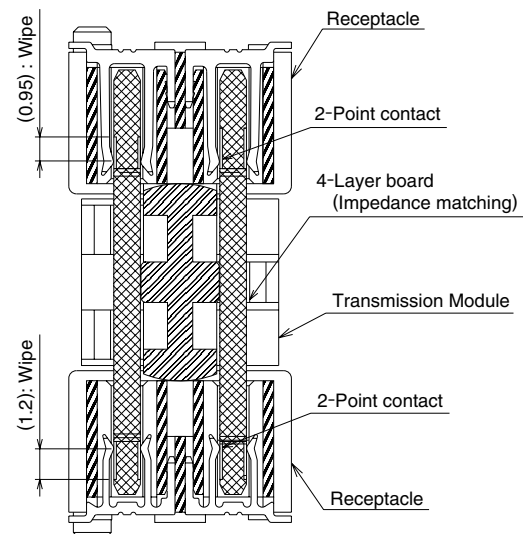


Receptacle (2 required)



Transmission Module

● Connection Cross-Sectional Diagram



■ Applications

Routers, servers, base stations and other telecommunication equipment.

Product Specifications

Rating	Current rating	0.4 A (Note 1)	Operation Temperature Range	-55°C to +85°C	Storage Temperature Range	-10°C to +60°C (Note 2)
	Voltage rating	50V AC	Operation Humidity Range	Relative humidity 95% max. (No condensation)	Storage Humidity Range	40% to 70% (Note 2)

Item	Specification	Conditions
1. Insulation resistance	100 M ohms min.	Measured at 100V DC
2. Withstanding voltage	No flashover or insulation breakdown	150 V AC/one minute
3. Contact resistance	100 m ohms max.	Measured at 100 mA
4. Vibration	No electrical discontinuity of 1 μ s or more. No damage, cracks, or parts dislocation.	Frequency of 10 to 55 Hz, 0.75mm single amplitude, for 10 cycles in each of 3 directions
5. Shock	No electrical discontinuity of 1 μ s. min. No damage, cracks, or parts dislocation	Acceleration of 490 m/s ² , 11 ms duration, sine half-wave waveform, 3 cycles in each of the 3 axis.
6. Humidity	Contact resistance: 110 m ohms max. Insulation resistance: 100 M ohms min. No damage, cracks, or parts dislocation	96 hours/40°C/ humidity of 90% to 95%
7. Temperature cycle	Contact resistance: 110 m ohms max. Insulation resistance: 100 M ohms min. No damage, cracks, or parts dislocation	Temperature: -55°C → +15°C to +35°C → +85°C → +15°C to +35°C Duration: 30 → 2 to 3 → 30 → 2 to 3 (Minutes) 5 cycles
8. Durability (insertion/ withdrawal)	Contact resistance: 110 m ohms max. No damage, cracks, or parts dislocation.	20 cycles
9. Resistance to Soldering Heat	No deformation of components affecting performance.	Reflow: At the recommended temperature profile Manual soldering: 350°C for 3 seconds

Note1: If the connector is going to be used at a current in excess of the 0.4 A, please contact your Sales Representative.

Note2: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating Temperature Range and Humidity range covers non-conducting condition of installed connectors in storage, shipment or during transportation.

Note3: Information contained in this catalog represents general requirements for this Series. Contact us for the drawings and specifications for a specific part number shown.

Material

Receptacles

Part	Material	Finish	Remarks
Insulator	LCP	Color : Beige	UL94V-0
Contacts	Phosphor bronze	Gold plating	—
Metal fittings	Phosphor bronze	Tin plating	—

Transmission Module

Part	Material	Finish	Remarks
Insulator	PBT	Color : Black	UL94V-0
Board	FR-4	Contact portion : Gold plating	—

Ordering information

Receptacles

IT 1 # - * S - SV (* *)

① ② ③ ④ ⑤ ⑥

Transmission Module

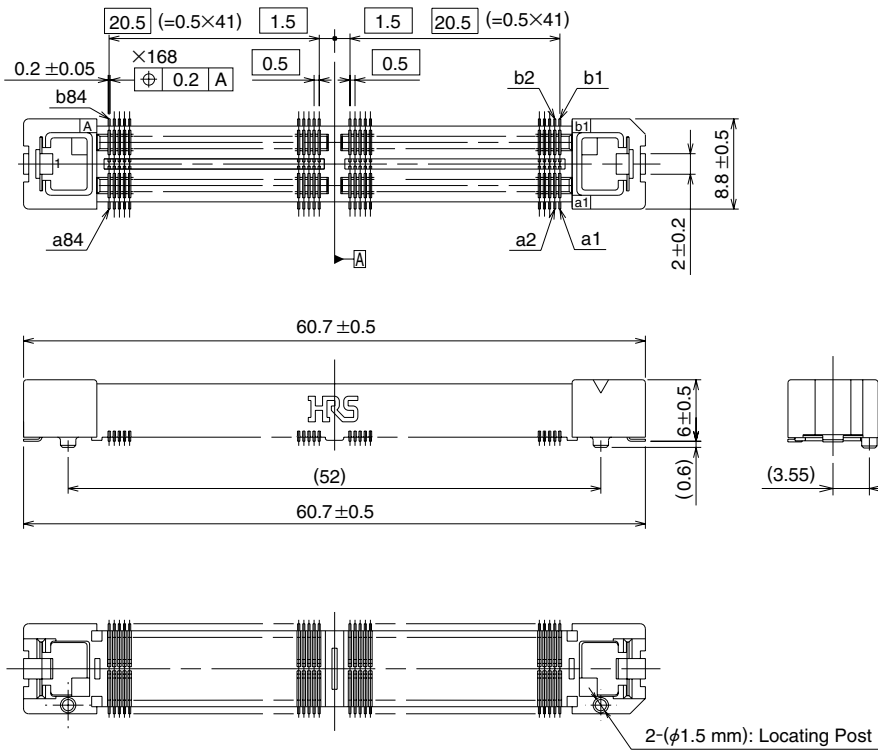
IT 1 - * P / * - *H

① ③ ④ ⑦ ⑧

① Series name	: IT1	⑤ Lead	SV : Straight SMT
② Locating Post type Blank	: With Locating Post	⑥ Packaging	Blank : Tray (25) : Tray(connectors with attached tape for a vacuum board placement)
A	: Without Locating Post		
③ Number of contacts	: 168, 252	⑦ Number of ground contacts	: 28, 44
④ Connector	S : Receptacle Socket P : Transmission Plug Module	⑧ Board-to-board Distance:	19mm,23mm,30mm

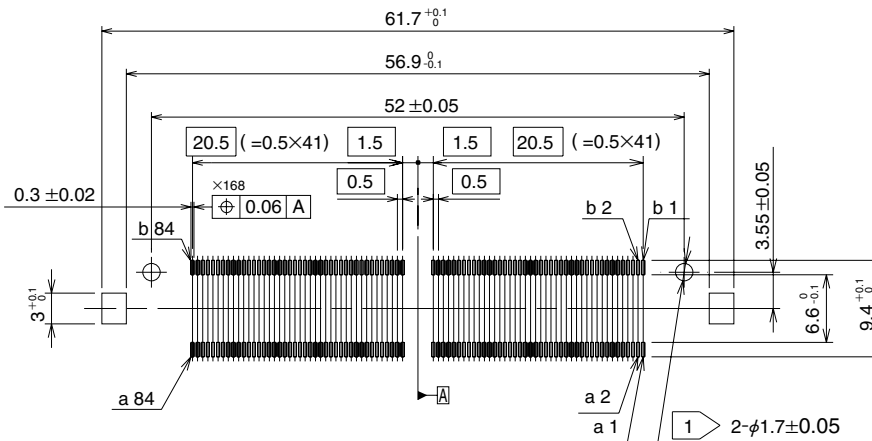
IT1 Series High Speed, Matched Impedance, Parallel Board-to-board Connector System

Receptacles - 168 Contacts



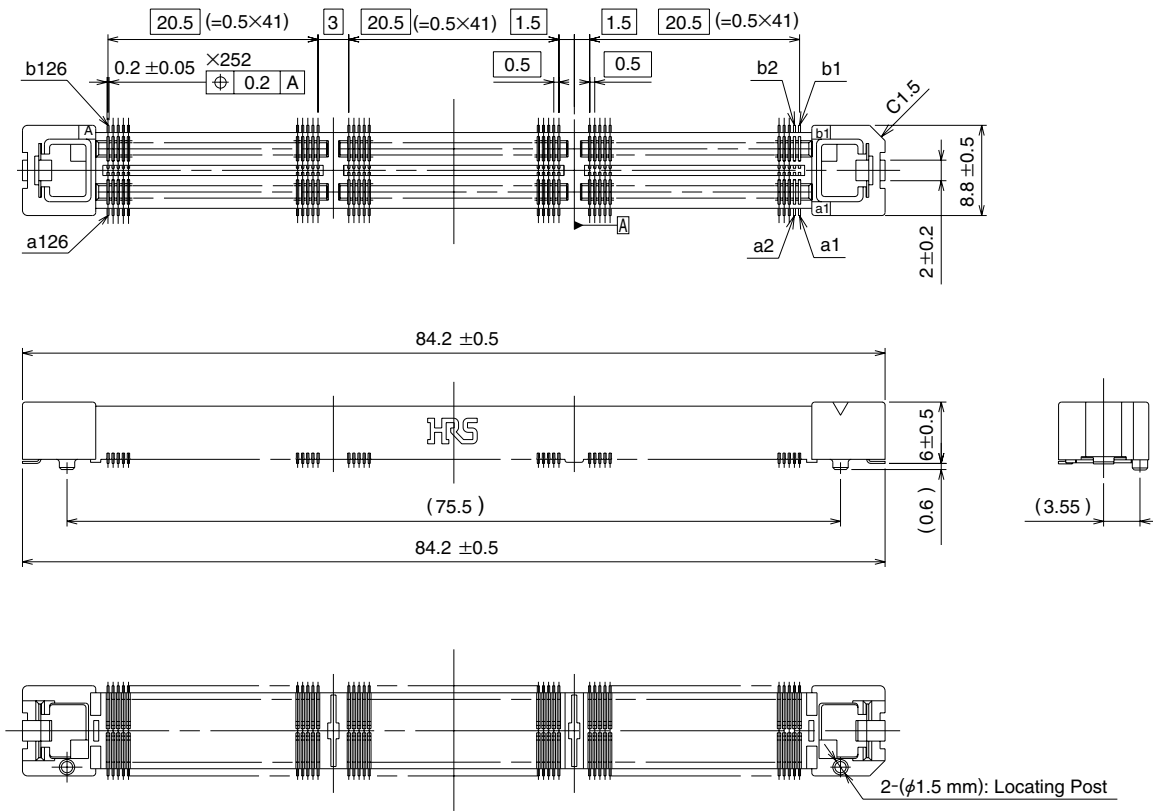
Part Number	CL No.	Locating Post Type	RoHS
IT1-168S-SV	641-0002-0	With Locating Post	YES
IT1A-168S-SV	641-0012-4	Without Locating Post	

Recommended PCB mounting pattern



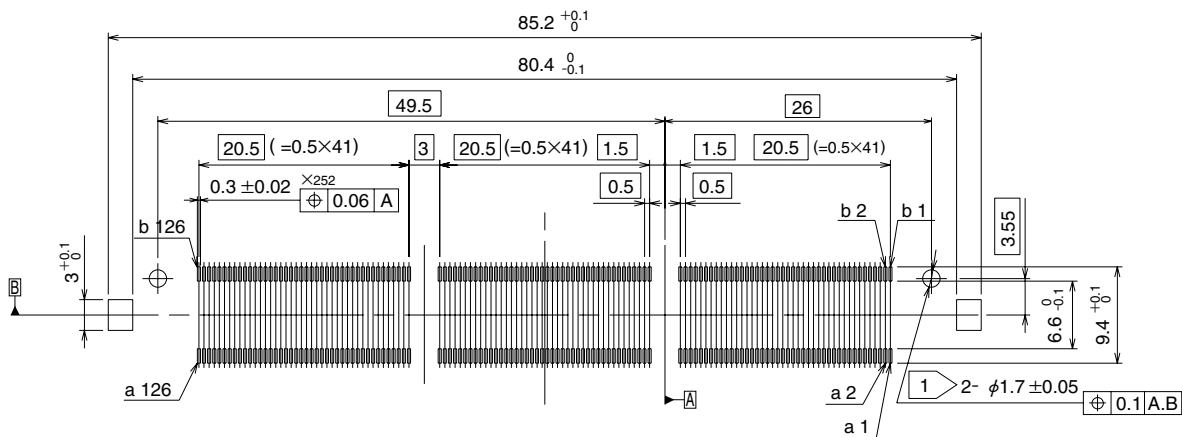
1 Not required for products without Locating Post.

Receptacles - 252 Contacts



Part Number	CL No.	Locating Post Type	RoHS
IT1-252S-SV	641-0003-3	With Locating Post	YES
IT1A-252S-SV	641-0013-7	Without Locating Post	

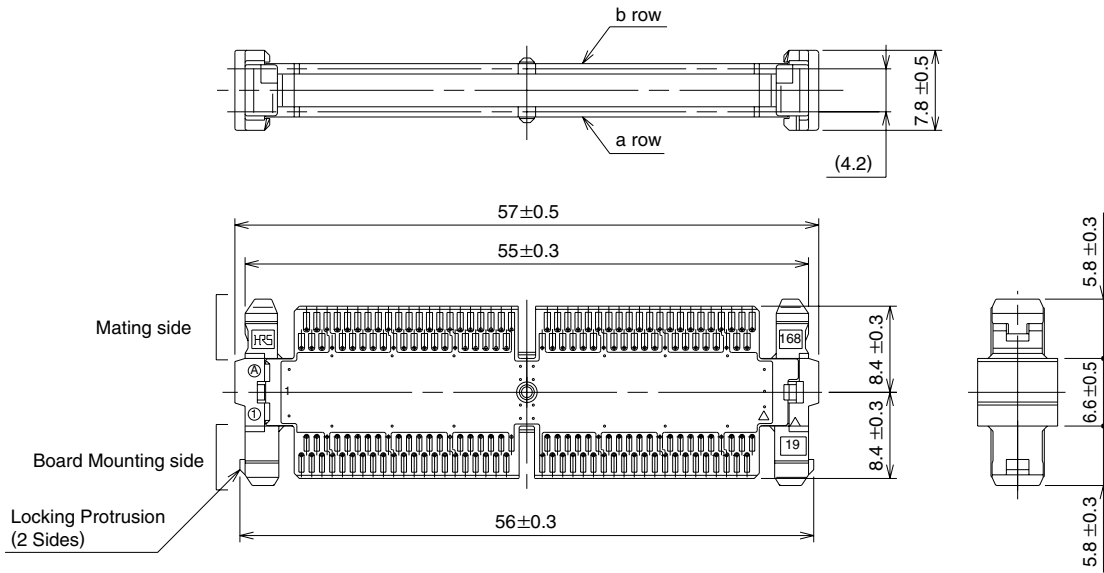
Recommended PCB mounting pattern



1 Not required for products without locating Post.

IT1 Series High Speed, Matched Impedance, Parallel Board-to-board Connector System

Transmission Module - 168 Contacts



Part Number	CL No.	Board-to-board Distance	A	B	C	RoHS
IT1-168P/28-19H	641-0192-8	19mm	8.4	8.4	6.6	YES
IT1-168P/28-30H	641-0303-7	30mm	13.9	13.9	17.6	

Connection Table

The connection table indicates contact numbers in the mated condition, as illustrated in Fig. 1.

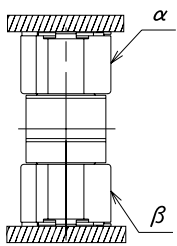


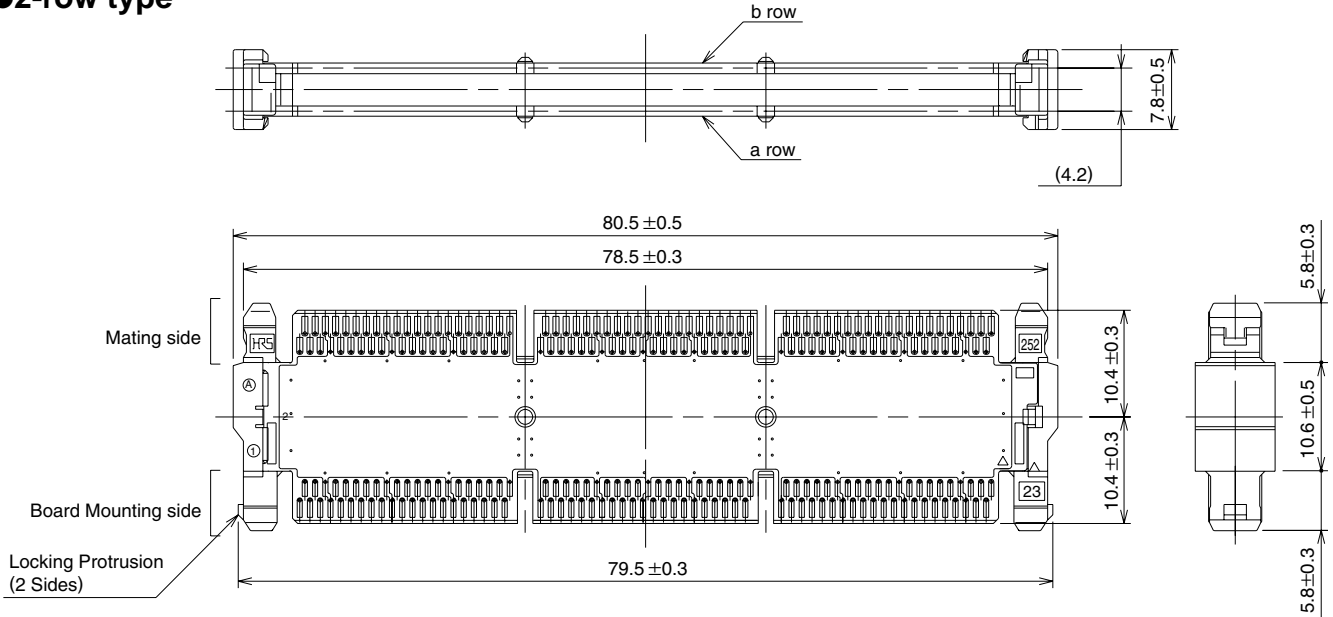
Fig. 1

		a row	
		α - β	α - β
Signal	a 1 - a84	Signal	a44 - a41
	a 2 - a83		
	a 3 - a82		
	a 4 - a81		
	a 5 - a80		a53 - a32
Ground	a 6 - a79	Ground	a54 - a31
	a 7 - a78		a55 - a30
Signal	a 8 - a77	Signal	a56 - a29
Ground	a17 - a68	Ground	a65 - a20
	a18 - a67		a66 - a19
Signal	a19 - a66	Signal	a67 - a18
	a20 - a65		a68 - a17
Ground	a29 - a56	Ground	a77 - a 8
	a30 - a55		a78 - a 7
	a31 - a54		a79 - a 6
Signal	a32 - a53	Signal	a80 - a 5
			a81 - a 4
			a82 - a 3
			a83 - a 2
	a41 - a44		a84 - a 1
Ground	a42 - a43	Ground	
	a43 - a42		

		b row	
		α - β	α - β
Signal	b 1 - b84	Signal	b44 - b41
	b 2 - b83		
	b 3 - b82		
	b 4 - b81		
	b 5 - b80		b53 - b32
Ground	b 6 - b79	Ground	b54 - b31
	b 7 - b78		b55 - b30
Signal	b 8 - b77	Signal	b56 - b29
Ground	b17 - b68	Ground	b65 - b20
	b18 - b67		b66 - b19
Signal	b19 - b66	Signal	b67 - b18
	b20 - b65		b68 - b17
Ground	b29 - b56	Ground	b77 - b 8
	b30 - b55		b78 - b 7
	b31 - b54		b79 - b 6
Signal	b32 - b53	Signal	b80 - b 5
			b81 - b 4
			b82 - b 3
			b83 - b 2
	b41 - b44		b84 - b 1
Ground	b42 - b43	Ground	
	b43 - b42		

Transmission Module - 252 Contacts

2-row type



Part Number	CL No.	Board-to-board Distance	A	B	C	RoHS
IT1-252P/44-23H	641-0231-8	23mm	10.4	10.4	10.6	YES
IT1-252P/44-30H	641-0304-0	30mm	13.9	13.9	17.6	

Connection Table

The connection table indicates contact numbers in the mated condition, as illustrated in Fig. 1.

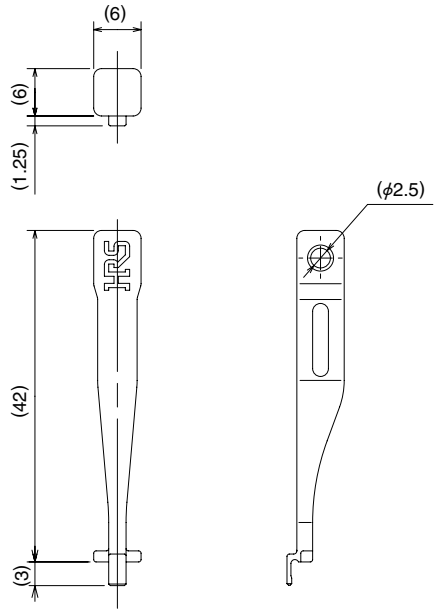
Fig. 1: Cross-section diagram of the connector showing the alpha (α) and beta (β) rows.

a row				b row			
	α - β		α - β		α - β		α - β
Signal	a 1 - a126	Signal	a44 - a83	Signal	b 1 - b126	Signal	b86 - b41
	a 5 - a122		a53 - a74		a95 - a32		
Ground	a 6 - a121	Ground	a54 - a73	Ground	b 5 - b122	Ground	b95 - b32
	a 7 - a120		a55 - a72		a96 - a31		
Signal	a 8 - a119	Signal	a56 - a71	Signal	b 6 - b121	Ground	b96 - b31
	a17 - a110		a57 - a70		a97 - a30		
Ground	a18 - a109	Ground	a58 - a69	Ground	b 7 - b120	Signal	b97 - b30
	a19 - a108		a60 - a68		a98 - a29		
Signal	a20 - a107	Signal	a61 - a67	Signal	b 8 - b119	Ground	b98 - b29
	a29 - a98		a62 - a65		a107 - a20		
Ground	a30 - a97	Ground	a63 - a64	Ground	b17 - b110	Signal	b107 - b20
	a31 - a96		a64 - a63		a108 - a19		
Signal	a32 - a95	Signal	a65 - a62	Signal	b18 - b109	Ground	b108 - b19
	a41 - a86		a66 - a61		a109 - a18		
Ground	a42 - a85	Ground	a67 - a60	Ground	b19 - b108	Signal	b109 - b18
	a43 - a84		a68 - a59		a110 - a17		
Signal	a44 - a83	Signal	a69 - a58	Signal	b20 - b107	Ground	b110 - b17
	a45 - a82		a70 - a57		a119 - a 8		
Signal	a46 - a81	Signal	a71 - a56	Signal	b29 - b98	Signal	b119 - b 8
	a47 - a80		a72 - a55		a120 - a 7		
Signal	a48 - a79	Signal	a73 - a54	Signal	b30 - b97	Ground	b120 - b 7
	a49 - a78		a74 - a53		a121 - a 6		
Signal	a50 - a77	Signal	a75 - a52	Signal	b31 - b96	Signal	b121 - b 6
	a51 - a76		a76 - a51		a122 - a 5		
Signal	a52 - a75	Signal	a77 - a50	Signal	b32 - b95	Ground	b122 - b 5
	a53 - a74		a78 - a49		b41 - b86		
Signal	a54 - a73	Signal	a79 - a48	Signal	b42 - b85	Signal	b83 - b44
	a55 - a72		a80 - a47		b43 - b84		
Signal	a56 - a71	Signal	a81 - a46	Signal	b44 - b83	Ground	b84 - b43
	a57 - a70		a82 - a45		b45 - b83		
Signal	a58 - a69	Signal	a83 - a44	Signal	b46 - b82	Signal	b85 - b42
	a59 - a68		a84 - a43		b47 - b81		
Signal	a60 - a67	Signal	a85 - a42	Signal	b48 - b80	Ground	b86 - b41
	a61 - a66		a86 - a41		b49 - b79		
Signal	a62 - a65	Signal	a87 - a40	Signal	b50 - b78	Signal	b87 - b40
	a63 - a64		a88 - a39		b51 - b77		
Signal	a64 - a63	Signal	a89 - a38	Signal	b52 - b76	Ground	b88 - b39
	a65 - a62		a90 - a37		b53 - b75		
Signal	a66 - a61	Signal	a91 - a36	Signal	b54 - b74	Signal	b89 - b38
	a67 - a60		a92 - a35		b55 - b73		
Signal	a68 - a59	Signal	a93 - a34	Signal	b56 - b72	Ground	b90 - b37
	a69 - a58		a94 - a33		b57 - b71		
Signal	a70 - a57	Signal	a95 - a32	Signal	b58 - b70	Signal	b91 - b36
	a71 - a56		a96 - a31		b59 - b69		
Signal	a72 - a55	Signal	a97 - a30	Signal	b60 - b68	Ground	b92 - b35
	a73 - a54		a98 - a29		b61 - b67		
Signal	a74 - a53	Signal	a99 - a28	Signal	b62 - b66	Signal	b93 - b34
	a75 - a52		a100 - a27		b63 - b65		
Signal	a76 - a51	Signal	a101 - a26	Signal	b64 - b64	Ground	b94 - b33
	a77 - a50		a102 - a25		b65 - b62		
Signal	a78 - a49	Signal	a103 - a24	Signal	b66 - b61	Signal	b95 - b32
	a79 - a48		a104 - a23		b67 - b60		
Signal	a80 - a47	Signal	a105 - a22	Signal	b68 - b59	Ground	b96 - b31
	a81 - a46		a106 - a21		b69 - b58		
Signal	a82 - a45	Signal	a107 - a20	Signal	b70 - b57	Signal	b97 - b30
	a83 - a44		a108 - a19		b71 - b56		
Signal	a84 - a43	Signal	a109 - a18	Signal	b72 - b55	Ground	b98 - b29
	a85 - a42		a110 - a17		b73 - b54		
Signal	a86 - a41	Signal	a111 - a16	Signal	b74 - b53	Signal	b99 - b28
	a87 - a40		a112 - a15		b75 - b52		
Signal	a88 - a39	Signal	a113 - a14	Signal	b76 - b51	Ground	b100 - b27
	a89 - a38		a114 - a13		b77 - b50		
Signal	a90 - a37	Signal	a115 - a12	Signal	b78 - b49	Signal	b101 - b26
	a91 - a36		a116 - a11		b79 - b48		
Signal	a92 - a35	Signal	a117 - a11	Signal	b80 - b47	Ground	b102 - b25
	a93 - a34		a118 - a10		b81 - b46		
Signal	a94 - a33	Signal	a119 - a 8	Signal	b82 - b45	Signal	b103 - b24
	a95 - a32		a120 - a 7		b83 - b44		
Signal	a96 - a31	Signal	a121 - a 6	Signal	b84 - b43	Ground	b104 - b23
	a97 - a30		a122 - a 5		b85 - b42		
Signal	a98 - a29	Signal	a123 - a 4	Signal	b86 - b41	Signal	b105 - b22
	a99 - a28		a124 - a 3		b87 - b40		
Signal	a100 - a27	Signal	a125 - a 2	Signal	b88 - b39	Ground	b106 - b21
	a101 - a26		a126 - a 1		b89 - b38		
Signal	a102 - a25	Signal	a126 - a 1	Signal	b90 - b37	Signal	b107 - b20
	a103 - a24		a126 - a 1		b91 - b36		
Signal	a104 - a23	Signal	a126 - a 1	Signal	b92 - b35	Ground	b108 - b19
	a105 - a22		a126 - a 1		b93 - b34		
Signal	a106 - a21	Signal	a126 - a 1	Signal	b94 - b33	Signal	b109 - b18
	a107 - a20		a126 - a 1		b95 - b32		
Signal	a108 - a19	Signal	a126 - a 1	Signal	b96 - b31	Ground	b110 - b17
	a109 - a18		a126 - a 1		b97 - b30		
Signal	a110 - a17	Signal	a126 - a 1	Signal	b98 - b29	Signal	b111 - b16
	a111 - a16		a126 - a 1		b99 - b28		
Signal	a112 - a15	Signal	a126 - a 1	Signal	b99 - b28	Ground	b112 - b15
	a113 - a14		a126 - a 1		b100 - b27		
Signal	a114 - a13	Signal	a126 - a 1	Signal	b101 - b26	Signal	b113 - b14
	a115 - a12		a126 - a 1		b102 - b25		
Signal	a116 - a11	Signal	a126 - a 1	Signal	b103 - b23	Ground	b114 - b13
	a117 - a11		a126 - a 1		b104 - b22		
Signal	a118 - a10	Signal	a126 - a 1	Signal	b105 - b19	Signal	b115 - b12
	a119 - a 8		a126 - a 1		b106 - b18		
Signal	a120 - a 7	Signal	a126 - a 1	Signal	b107 - b16	Ground	b116 - b11
	a121 - a 6		a126 - a 1		b108 - b15		
Signal	a122 - a 5	Signal	a126 - a 1	Signal	b109 - b13	Signal	b117 - b10
	a123 - a 4		a126 - a 1		b110 - b12		
Signal	a124 - a 3	Signal	a126 - a 1	Signal	b111 - b10	Ground	b118 - b 9
	a125 - a 2		a126 - a 1		b112 - b 9		
Signal	a125 - a 2	Signal	a126 - a 1	Signal	b113 - b 8	Signal	b119 - b 8
	a126 - a 1		a126 - a 1		b114 - b 7		
Signal	a126 - a 1	Signal	a126 - a 1	Signal	b115 - b 6	Ground	b120 - b 7
	a126 - a 1		a126 - a 1		b116 - b 5		
Signal	a126 - a 1	Signal	a126 - a 1	Signal	b117 - b 5	Signal	b121 - b 6
	a126 - a 1		a126 - a 1		b118 - b 4		
Signal	a126 - a 1	Signal	a126 - a 1	Signal	b119 - b 3	Ground	b122 - b 5
	a126 - a 1		a126 - a 1		b120 - b 2		
Signal	a126 - a 1	Signal	a126 - a 1	Signal	b121 - b 1	Signal	b123 - b 4
	a126 - a 1		a126 - a 1		b122 - b 1		
Signal	a126 - a 1	Signal	a126 - a 1	Signal	b123 - b 4	Ground	b124 - b 3
	a126 - a 1		a126 - a 1		b124 - b 2		
Signal	a126 - a 1	Signal	a126 - a 1	Signal	b125 - b 2	Signal	b125 - b 2
	a126 - a 1		a126 - a 1		b126 - b 1		
Signal	a126 - a 1	Signal	a126 - a 1	Signal	b126 - b 1	Ground	b126 - b 1
	a126 - a 1		a126 - a 1		b126 - b 1		

IT1 Series High Speed, Matched Impedance, Parallel Board-to-Board Connector System

◆IT1 Series Extraction Tool

Part Number	CL No.	Remarks	RoHS
IT1-PICKER(1)	641-1001-3	2-piece Package	YES



Installation and Use Instruction Manual

Table of Contents

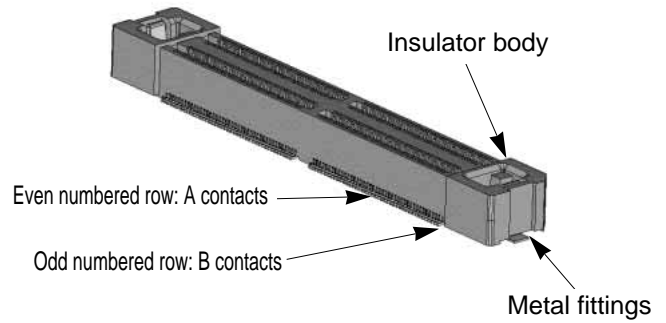
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• Extraction Tool	
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◆ Connector Handling Precautions

1. System components

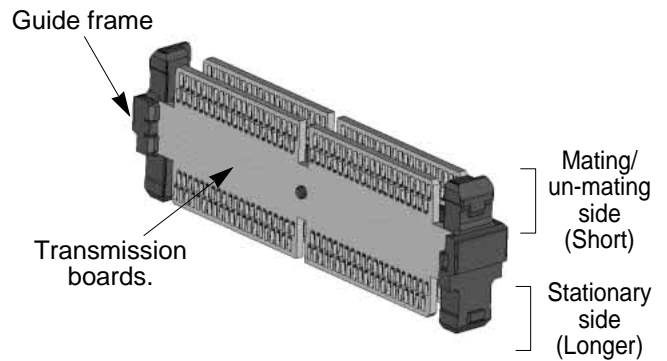
■ Receptacles

- **Contacts**
Row A and row B contacts are arranged alternately starting with No.1 in row B. Placement on board is polarized.
- **Metal Fittings**
Permanently inserted to provide lock with the Transmission Module and additional solder areas with the PCB.
- **Insulator body**
Injection molded single unit provides protection and correct self-alignment of all components.



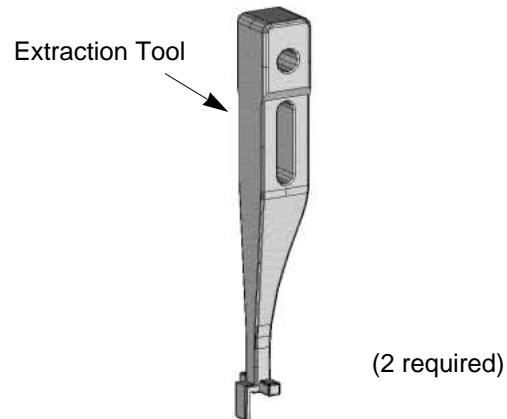
■ Transmission Module Assembly

- Each Module has stationary side and a mating/un-mating side.
- When mounting multiple connectors, please keep uniform orientation of the stationary side.
- Transmission printed circuit boards used in the module are based on JIS standards and quality standards applicable to memory modules.



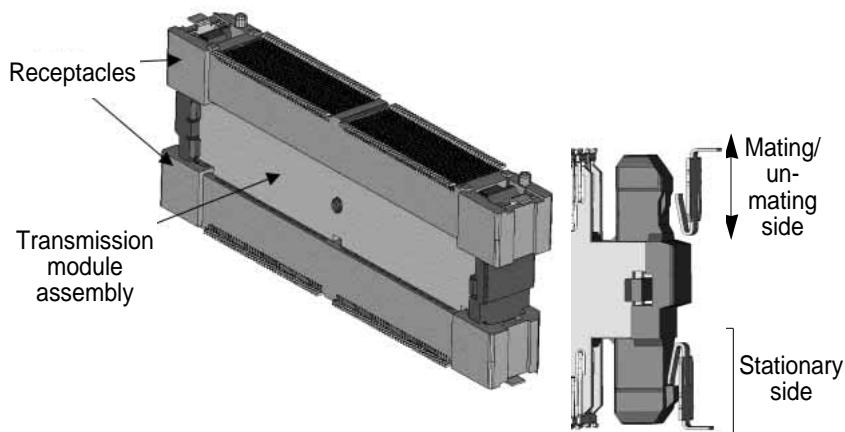
■ Extraction Tool

- Used to release the transmission module from the stationary receptacle.



Fully Connected Condition

The interconnection package consists of 3 main sub-assemblies: Two receptacles and the Transmission Module. The transmission module, held securely by the guide frame has a mating/un-mating side and a stationary side. Once the stationary side is inserted in the receptacle, it can not be removed without the use of extraction tool. The mating/un-mating side allows repeated re-insertion of the receptacle on this side only.



2. Recommended Design Guidelines

2-1 Solder Land Pattern

When placing the receptacles on the Printed Circuit Boards using automatic mounting equipment or manually, assure that the correct diameters of the holes (Fig. 1) are through the entire thickness of the board.

◆ Locating post hole diameter ◆

The contacts of receptacle assembly are exposed on the bottom surfaces. The exposed areas of the contacts are a distance of 0.25 mm minimum from the surface of the Printed Circuit Board, on which the receptacle assembly is placed (Fig.2). Consideration should be taken not to place or assure insulation of conductive traces under the receptacle assemblies.

Refer to the separate drawings for recommended solder land pattern dimensions of the receptacle, and signals and ground connection diagram of the transmission module.

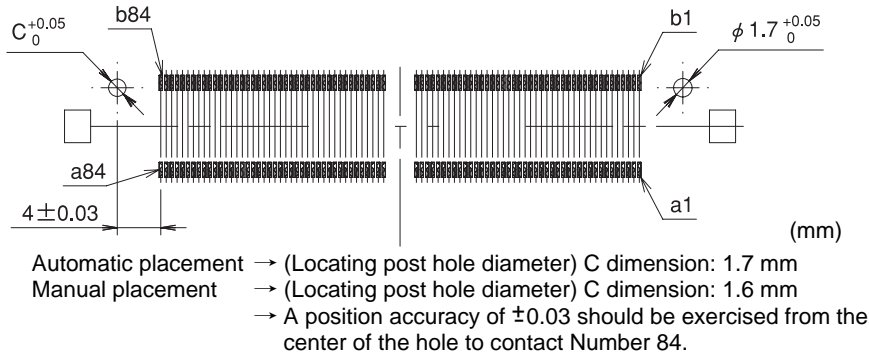


Fig. 1 IT1-168S-SV Recommended Solder Land Pattern

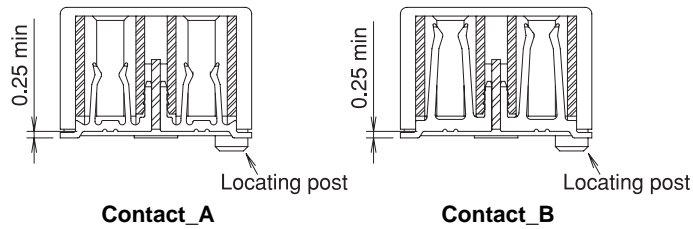


Fig. 2 Cross section of IT1 receptacle

2-2 Board-to-Board Spacer heights

The two parallel boards connected by the IT1 connectors should be fastened to additional spacers between them.

Fig. 3 indicates the connector height tolerance and the spacer's height.

When designing the spacer's height, consideration should be given to the solder paste thickness and any other features, which may affect the full mating of the connector.

Fig. 3 indicates design dimensions for the 19 mm board-to-board distance.

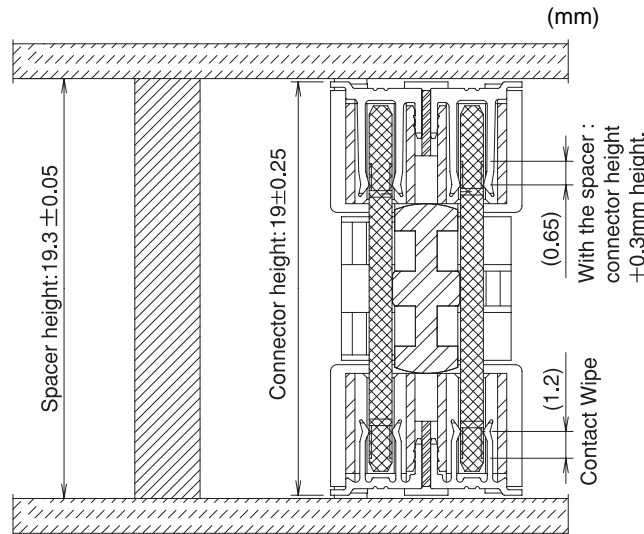


Fig. 3

IT1 Series High Speed, Matched Impedance, Parallel Board-to-board Connector System

3. Connector Placement

3-1 Packaging Types

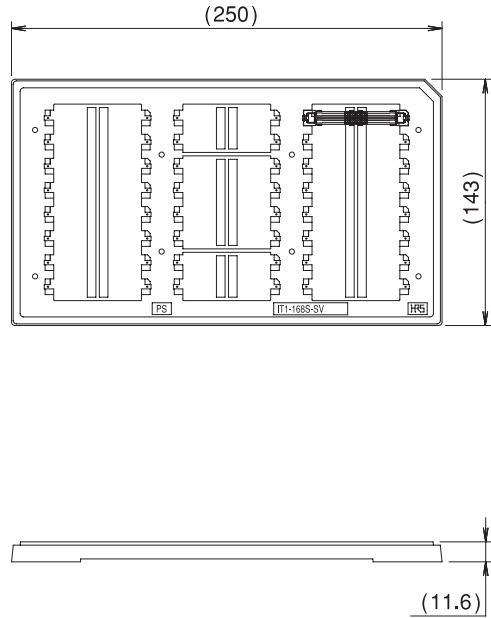
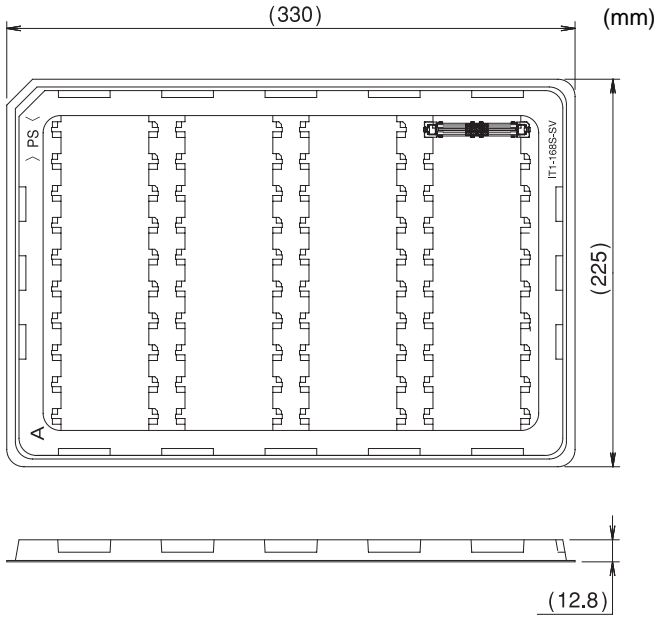
- Two types of packaging are available: semi-hard tray and hard tray. Customers may specify a packaging type suitable for their automatic placement machines.
- * Refer to the separate drawings for the detailed dimensions of the trays.

• Semi-hard tray packaging

168 contacts receptacle: 40 pieces per tray
 252 contacts receptacle: 30 pieces per tray

• Hard tray packaging

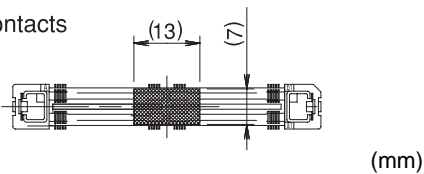
168 contacts receptacle: 24 pieces per tray
 252 contacts receptacle: 16 pieces per tray



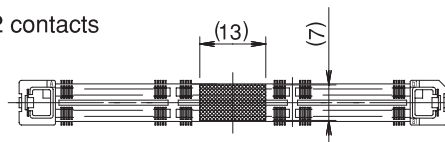
3-2 Automatic placement - Vacuum Pick-and-Place Areas

- Specify "Vacuum Pick-up Tape Specification".
 The area and position of the pick-and-place surface are indicated in the diagrams below.

• 168 contacts



• 252 contacts



3-3 Receptacle Board Placement

- When using automatic placement equipment, verify the packaging type and the Pick-and-place areas.
- When placing manually, pay attention to the possibility of positional shift. Ref. Fig. 4.
- * When placing multiple connectors, to assure positional accuracy, it is advised to use automatic placement equipment.

◆ Precautions for Manual Placement ◆

The orientation posts serve as a prevention measure to avoid incorrect placement of the receptacle assemblies on the board. The contact terminals must be placed correctly over the corresponding solder pad as shown on Fig. 4-1.

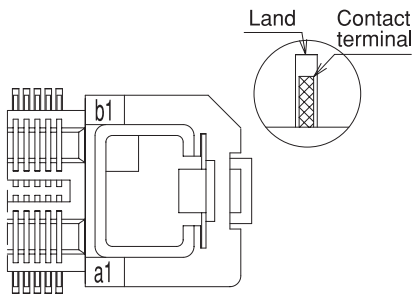


Fig. 4-1 = Correct

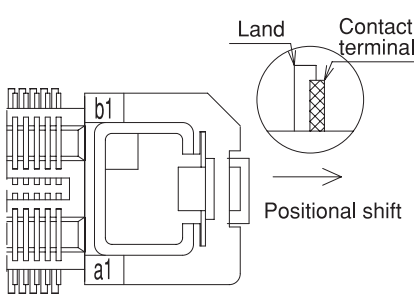


Fig. 4-2 = Incorrect

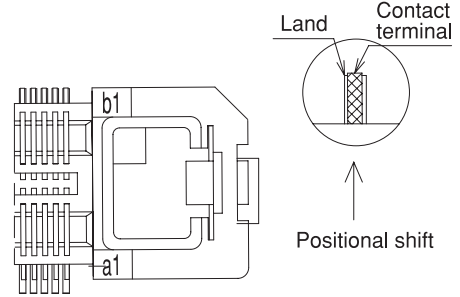
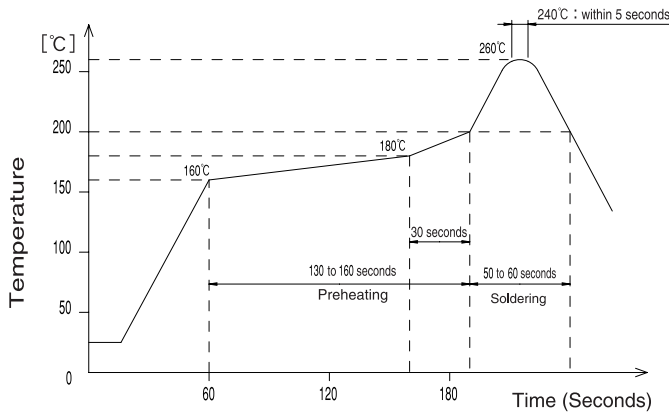


Fig. 4-3 = Incorrect

3-4 Recommended Reflow Conditions



Applicable Conditions

- Reflow system : IR reflow
- Solder : Paste type (Sn:96.5, AG:3.0, Cu:5.0)
(Flux content 9wt%)
- Test board : Glass epoxy (FR-4), 85mm x 110mm x 1.6 mm
- Metal mask thickness : 0.15 mm

* Shown recommended temperature profile.

HP Series High Speed, Matched Impedance, Parallel Board-to-board Connector System

3-5 Solder Repairs

Assure that flux is not reaching the contact areas of the connector.
Wash the assembly as recommended below.

◆Cleaning Conditions◆

<Organic Solvent Cleaning>

Solvent Type	Normal temperature	Heated
IPA (Isopropyl alcohol)	Good	Good

<Water Based Cleaning>

When using water based cleaning agents (e.g., terpene, and alkali saponifiers), select the cleaning agent based on the documentation issued by the various manufacturers, which describes its effects on metals and resins. Care should be taken not to leave moisture on the connectors.

<Cleaning Precautions>

Residual flux or cleaning agent remaining on the connectors when cleaning with organic solvents or water based cleaners may cause deterioration of the electrical performance. It is important to check that a thorough washing has been performed.

4. Mating Procedure

Follow the procedure described below.

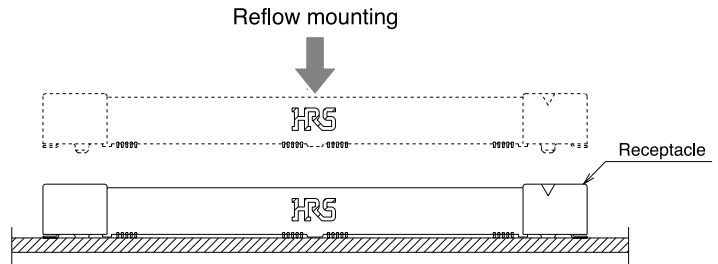
- Note:
- The transmission module must be fully inserted into receptacle assembly already placed and soldered to a board.
 - The Transmission Module cannot be exposed to heat temperatures of the soldering process.

Step 1

Receptacle Placement on the board – stationary side

Assure that the orientation posts are aligned with the holes on the board.

When specifying receptacle assemblies without the orientation posts exercise extra caution to assure correct orientation and connection with the solder pads.

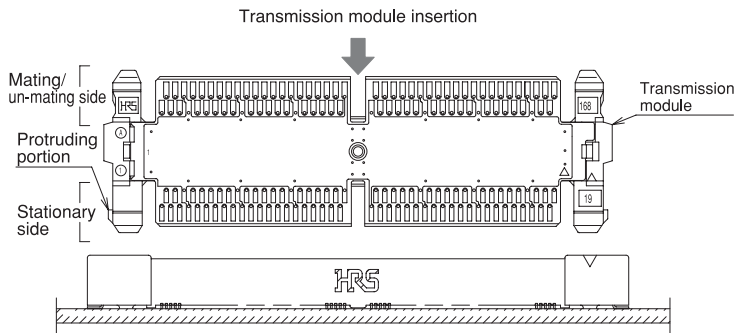


Step 2

Insertion of the Transmission Module

Fully insert the Transmission Module in the board-installed receptacle assembly.

It is critical that the insertion is done straight and uniformly.



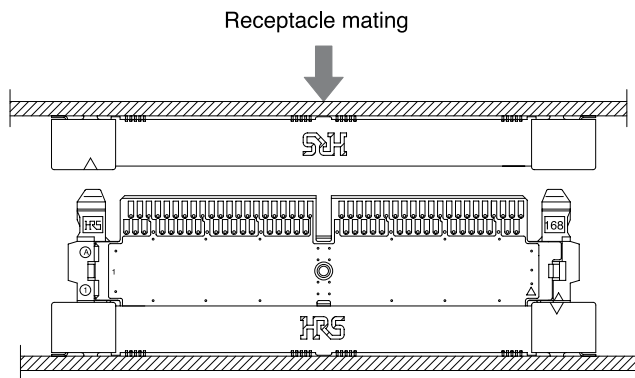
Step 3

Mating/un-mating

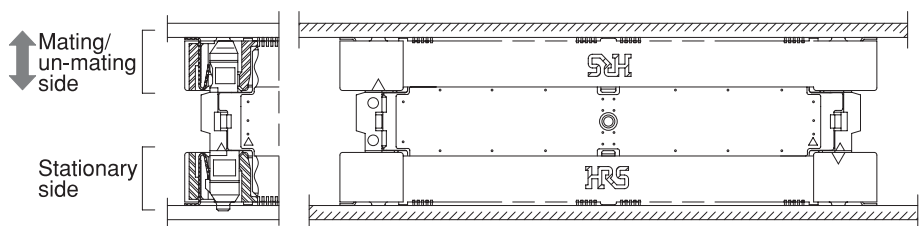
Assure that the receptacle assembly is correctly aligned with the Transmission Module.

Fully insert the receptacle assembly on the Transmission Module.

It is critical that the insertion is done straight and uniformly.



Step 4

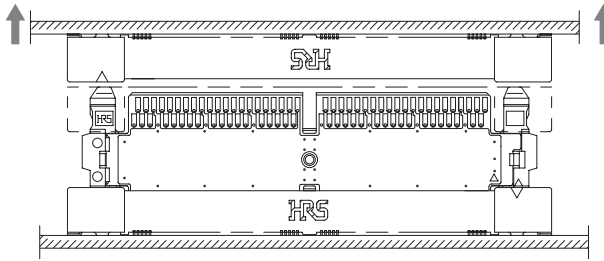


HM Series High Speed, Matched Impedance, Parallel Board-to-Board Connector System

5. Un-mating of Connectors

Recommended Method

- Pull uniformly straight up.



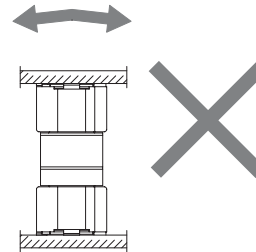
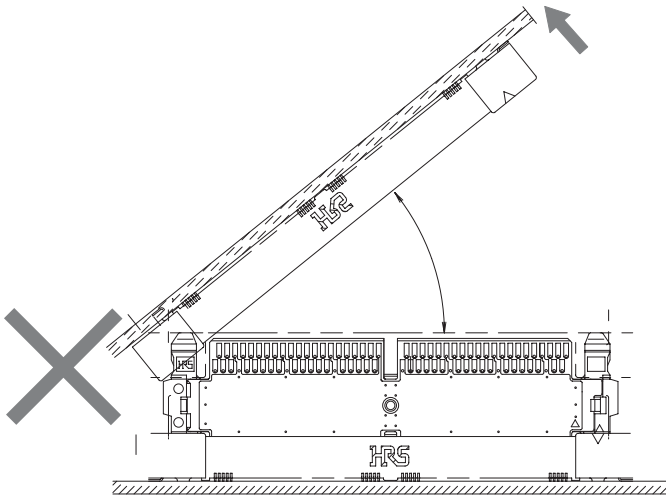
Prohibited un-mating Methods



- Do not lift by one side only.



- Do not wiggle side-to-side.



- Do not mate/un-mate when connections are under power.

6. Removal of the Transmission Module - stationary side

- Requires use of dedicated extraction tool. Two are required.

Step 1

- Fully insert the tools into each end of the receptacle assembly (Fig. 1) assuring that they will be over the hold areas of the Transmission Module frame. Ref. Fig. 2

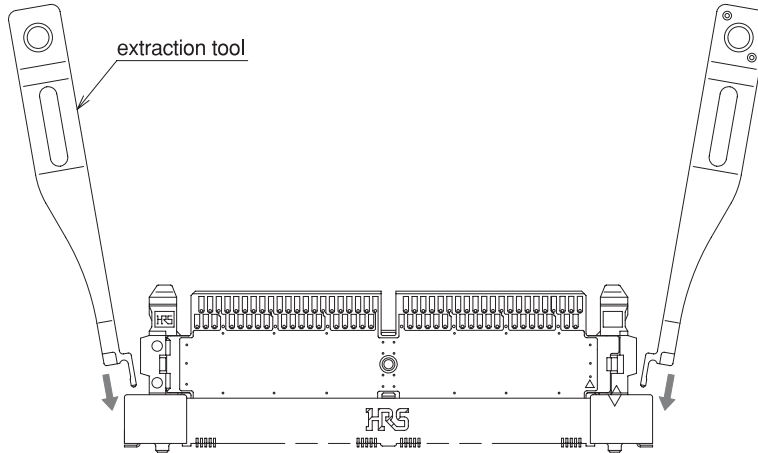


Fig. 1

Step 2

- Pull out the transmission module holding the tools straight.

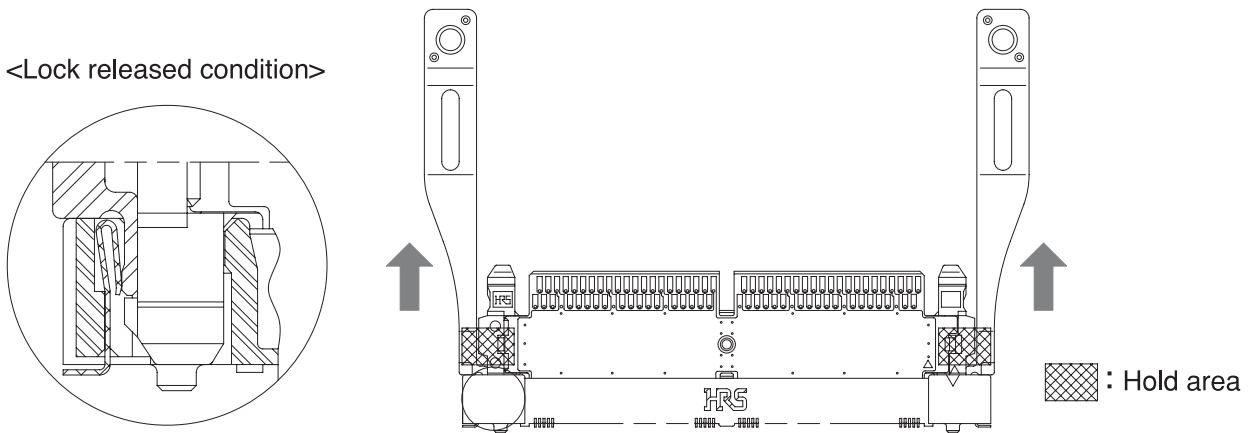
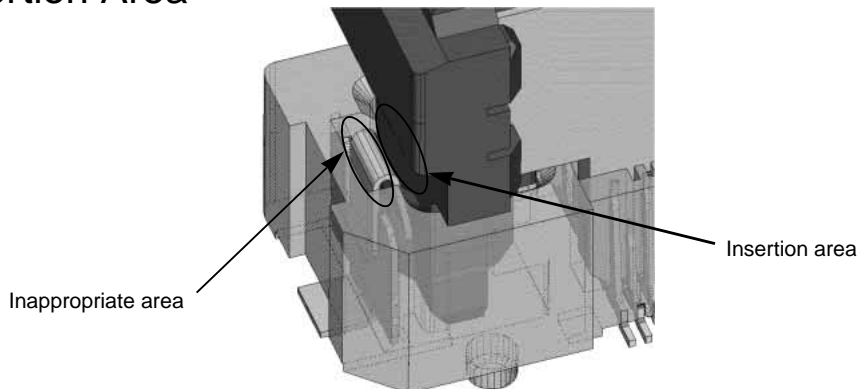


Fig. 2

extraction tool Insertion Area



H1 Series High Speed, Matched Impedance, Parallel Board-to-Board Connector System

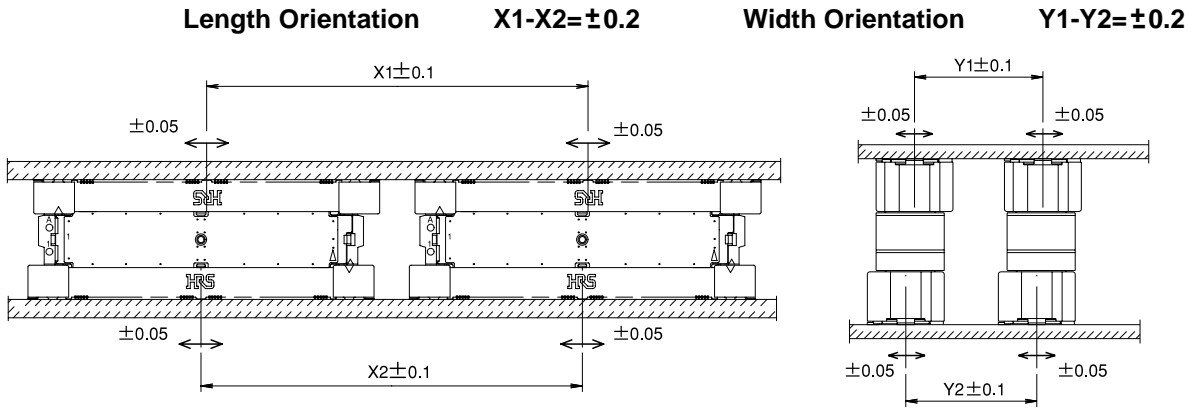
7. Precautions When Mounting Multiple Connectors

Note: Observe the requirements as listed in paragraph 7-1 and 7-2.

The mating/un-mating forces will increase with use of multiple assemblies. It is recommended that a dedicated tooling is used for mating / un-mating of multiple connector assemblies in a single operation.

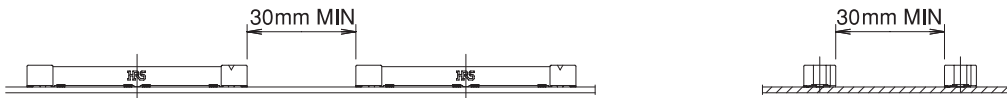
7-1 Allowable Amount of Misalignment

Maximum allowable misalignment in X and Y directions is ± 0.2 mm total.
 Refer to the drawings below.



7-2 Recommended Connector Placement

It is recommended to leave min. of 30 mm space between the adjacent connector assemblies.



7-3 Examples of Prohibited Placement Positions

To assure reliability of solder joints and mating/ un-mating without damage, **DO NOT PLACE MULTIPLE CONNECTORS** as illustrated below.

